

Layer	Stack up	Supplier	Description	Туре	Base Thickness	εr	Processed Thickness	Impedance ID	Mask Thickness		
Layer			•		THICKICSS			Impedance ib			
		•	PSR-4000BN (semi gloss)	soldermask		4.500			0.800		
1			1/2 oz copper foil	foil	0.600			1, 2			
		Isola	FR408HR 106(75) pre-preg	pre-preg	2.300		2.240				
		Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230	2.240				
2					1.200		1.200				
3		Isola	FR408HR .004 (106/1080-59) 1/1 core*	core	4.000 1.200	3.570	1.200	3			
ŭ		Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230					
			FR408HR 106(75) pre-preg	pre-preg	2.300	3.230					
4		13014	Triadoriit 100(70) pre-preg	pre-preg	1.200	3.230		4, 5			
4		Isola	FR408HR .004 (106/1080-59) 1/1 core*	core	4.000	3.570		4, 5			
5					1.200		1.200				
	000	Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230	2.180				
	+6.200 /-6.200	Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230	2.180				
6	00				1.200		1.200				
7	6.2	Isola	FR408HR .004 (106/1080-59) 1/1 core*	core	4.000 1.200	3.570	4.000 1.200				
,	+	Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230					
	0		, ,, . .		2.300	3.230					
	59	Isola	FR408HR 106(75) pre-preg	pre-preg		3.230					
8		Isola	FR408HR .004 (106/1080-59) 1/1 core*	core	1.200 4.000	3.570	1.200 4.000				
9					1.200		1.200	6			
	[§	Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230	2.180				
		Isola	FR408HR 106(75) pre-preg	pre-preg	2.300	3.230	2.180				
10					1.200		1.200	7			
11		Isola	FR408HR .004 (106/1080-59) 1/1 core*	core	4.000 1.200	3.570	4.000 1.200				
11			ED 400/ ID 400/75)			0.000					
			FR408HR 106(75) pre-preg	pre-preg	2.300	3.230					
			FR408HR 106(75) pre-preg	pre-preg	2.300	3.230					
12			1/2 oz copper foil	foil	0.600			8, 9			
		Taiyo	PSR-4000BN (semi gloss)	soldermask		4.500	0.800		0.800		

Copper Thickness = 15.200 | Dielectric Thickness = 46.400 | Solder Mask Thickness = 1.600 | Stack Up Thickness = 61.600 | Stack Up Thickness with Soldermask = 63.200

Structure Image	Impedance ID	Structure Name	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Upper Trace Width (W2)	Trace Separation (S1)	Ground Strip Separation (D1)	Target Impedance	Calculated Impedance	Tol (+/- %)	MIN Trace FAIL	MAX Trace FAIL	Measured Trace	OP Initial	
	1	Coated Microstrip 1B	1	2	0	8.500	8.000	0.000	0.000	50.000	50.410	10.000					
	2	Edge Coupled Coated Microstrip 1B	1	2	0	5.000	4.500	5.000	0.000	100.000	100.690	10.000					
	3	Offset Stripline 1B2A	3	2	5	5.000	4.500	0.000	0.000	50.000	50.260	10.000					

StackName: Ac Stack 5212020 1103 ciq	Version:	Revision:	Modification:	Date of Revision:	Editor		
Date: 5/21/2020	Associated Documents:					_	
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Department: CI Eng							
Site:							



Structure Image	Impedance ID	Structure Name	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Upper Trace Width (W2)	Trace Separation (S1)	Ground Strip Separation (D1)	Target Impedance	Calculated Impedance	Tol (+/- %)	MIN Trace FAIL	MAX Trace FAIL	Measured Trace	OP Initial		
	4	Offset Stripline 1B2A	4	2	5	5.000	4.500	0.000	0.000	50.000	50.260	10.000						
	5	Edge Coupled Offset Stripline 1B2A	4	2	5	3.800	3.300	6.100	0.000	100.000	100.850	10.000						_
	6	Offset Stripline 1B2A	9	8	11	5.000	4.500	0.000	0.000	50.000	50.260	10.000						_
	7	Offset Stripline 1B2A	10	8	11	5.000	4.500	0.000	0.000	50.000	50.260	10.000						
	8	Coated Microstrip 1B	12	11	0	8.500	8.000	0.000	0.000	50.000	50.410	10.000						
	9	Edge Coupled Coated Microstrip 1B	12	11	0	8.300	7.800	4.500	0.000	80.000	80.580	10.000						

Drill Image	1st Layer	2nd Layer	Column Position		Different Hole Sizes	Data Filenames	Minimum Siz
7	1	12	1	Mechanical PTH	0		20.000

<u>Notes</u>

Supplier	Supplier Description	Description	Туре	Total Quantity
Taiyo	PSR-4000BN (semi gloss)	PSR-4000BN (semi gloss)	soldermask	2
Isola	1/2 oz copper foil	1/2 oz copper foil	foil	2
Isola	FR408HR 106(75) pre-preg	FR408HR 106(75) pre-preg	pre-preg	12
Isola	FR408HR .004 (106/1080-59) 1/1 core*	FR408HR .004 (106/1080-59) 1/1 core*	core	5

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No. of Panels = 1 | Circuits Per Panel = 1 | Price Per Circuit = 20.00 |